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Complete if Known **Application Number** 10/678,438 Filing Date 3 October 2003

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use as many sheets as necessary)

First Named Inventor Vladimir V. MAKAROV Art Unit **Examiner Name**

Sheet 1 Attorney Docket Number 65.0395 of 15

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Examiner Initials*	Cite No. ¹	Document Number Number-Kind Code ^{2 (# known)}	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, When Relevant Passages or Relevan Figures Appear
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Complete if Known						
Application Number	10/678,438					
Filing Date	3 October 2003					
First Named Inventor	Vladimir V. MAKAROV					
Art Unit						
Examiner Name		_				
Attorney Docket Number	SE 020E					

U. S. PATENT DOCUMENTS Examiner **Document Number** Publication Date Name of Patentee or Pages, Columns, Lines, Where No. Initials* MM-DD-YYYY Applicant of Cited Document Relevant Passages or Relevant Number-Kind Code^{2 (F known)} Figures Appear ^{US-} 6,031,299 SA 02-29-2000 -Keekley et al- Stumpallela US- 6,057,223 05-02-2000 Lanford et al. ^{US-} 6,140,655 10-31-2000 Russell et al. US- 6.322,672 11-27-2001 Shuman et al. ^{US-} 2002/0094694 07-18-2002 SA Russell et al. US-USiis. US-US-US-USus. US-US-US-US-US-

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		NON PATENT LITERATURE DOCUMENTS			
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Application Number 10/678,438

INFORMATION DISCLOSURE Filing Date 3 October 2003

STATEMENT BY APPLICANT First Named Inventor Vladimir V. MAKAROV

Art Unit Examiner Name

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		NON PATENT LITERATURE DOCUMENTS			
Examiner Initials* Cite No.1		Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issuments, publisher, city and/or country where published.			
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	*	NON PATENT LITERATURE DOCUMENTS	4	
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